FR1AD THRU FR1MD

SURFACE MOUNT FAST RECOVERY RECTIFIER

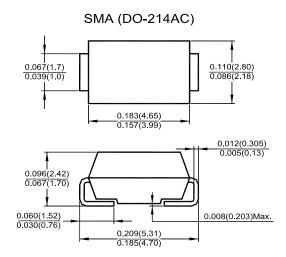
Reverse Voltage - 50 to 1000 V Forward Current - 1 A

Features

- · For surface mounted applications
- · Low profile package
- · Built-in strain relief
- · Easy pick and place
- · Fast Recovery times for high efficiency
- Plastic package has UL Flammability Classification 94V-0

Mechanical Data

- Case: Molded plastic, SMA (DO-214AC)
- Terminals: Solder plated, solderable per MIL-STD-750, method 2026 guaranteed
- · Polarity: color band denotes cathode end



Dimensions in inches and (millimeters)

Maximum Ratings and Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified. Single phase, half wave, 60 Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Parameter	Symbols	FR1AD	FR1BD	FR1DD	FR1GD	FR1JD	FR1KD	FR1MD	Units
Maximum Recurrent Peak Reverse Voltage	V_{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS Voltage	V _{RMS}	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	V_{DC}	50	100	200	400	600	800	1000	V
Maximum Average Forward Current T _L = 90°C	I _{F(AV)}	1							Α
Peak Forward Surge Current, 8.3 ms Single Half Sine Wave Superimposed on Rated Load (JEDEC method)	I _{FSM}	30						Α	
Maximum Forward Voltage at I _F = 1 A	V_{F}	1.3						V	
Maximum Reverse Current at $T_a = 25^{\circ}C$ Rated DC Blocking Voltage $T_a = 125^{\circ}C$	I _R	5 150							μA
Maximum Reverse Recovery Time 1)	t _{rr}	150			250	500		ns	
Typical Junction Capacitance 2)	CJ	12							pF
Typical Thermal Resistance 3)	$R_{\theta JL}$	32						°C/W	
Operating and Storage Temperature Range	T_J , T_{Stg}	- 55 to + 150							°C

 $^{^{1)}}$ Reverse recovery test conditions: $I_F = 0.5 \text{ A}$, $I_R = 1 \text{ A}$, $I_{rr} = 0.25 \text{ A}$

 $^{^{3)}}$ Thermal resistance from junction to lead mounted on P.C.B. with 0.3 X 0.3" (8 X 8 mm) copper pad areas



 $^{^{\}rm 2)}{\rm Measured}$ at 1 MHz and applied reverse voltage of 4 V

RATING AND CHARACTERISTIC CURVES

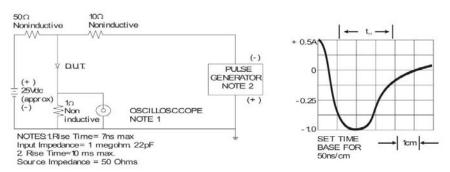


Fig. 1-REVERSE RECOVERY TIME CHARACTERISTIC AND TEST CIRCUIT DIAGRAM

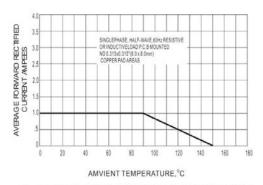


Fig. 2-MAXIMU AVERAGE FORWARD CURRENT RATING

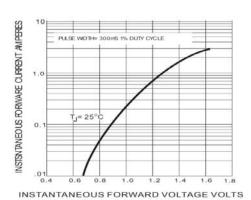


Fig. 3- TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

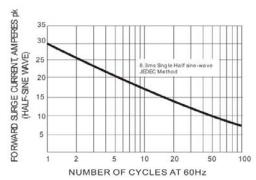


Fig.4-MAXIMUM NON-REPEITIVE SURGE CURRENT

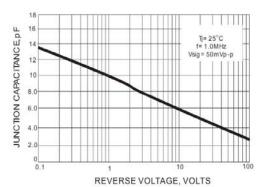


Fig.5-TYPICAL JUNCTION CAPACITANCE

